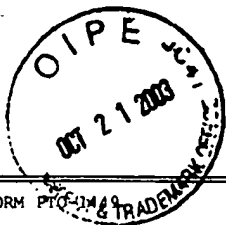


| | | | | | | | | |
|--|----|------------------------------|----------|---------------|-------------------------|-----------------------|----------------------------|----|
| FORM P-449 U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE | | ATTORNEY DOCKET NO. 1683.018 | | | | SERIAL NO. 10/623,955 | | |
| LIST OF ART CITED BY APPLICANT (Use several sheets if necessary) | | APPLICANT: Mr. Hakjin Kim | | | | | | |
| | | FILING DATE: Herewith | | | | GROUP | | |
| U.S. PATENT DOCUMENTS | | | | | | | | |
| Examiner Initial | | DOCKET NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE | |
| Q+ | AA | 2,193,882 | 3/19/40 | H.O. PETERSEN | | | | |
| | AB | 2,310,106 | 2/02/43 | J.G. MILLER | | | | |
| | AC | 2,359,933 | 10/10/44 | H.D. NIBLACK | | | | |
| | AD | 2,781,040 | 2/12/57 | B. HILL | | | | |
| | AE | 2,874,689 | 2/24/59 | J.W. GAVELEK | | | | |
| | AF | 2,909,173 | 10/20/59 | O.F. ANDERSON | | | | |
| | AG | 3,687,133 | 8/29/72 | GRUBELIC | | | | |
| | AH | 3,877,422 | 4/15/75 | HEUSER ET AL. | | | | |
| | AI | 4,190,043 | 2/26/80 | THOMPSON | | | | |
| | AJ | 4,458,675 | 7/10/84 | NAKAO ET AL. | | | | |
| | AK | 4,586,493 | 5/06/86 | GOODMAN | | | | |
| | AL | 4,656,998 | 4/14/87 | MASUDA ET AL. | | | | |
| | AM | 4,899,403 | 2/13/90 | YAMASAKI | | | | |
| | AN | 4,947,833 | 8/14/90 | YAMASAKI | | | | |
| | AO | 5,038,757 | 8/13/91 | YAMASAKI | | | | |
| | AP | 5,088,475 | 2/18/92 | STEFFENSMEIER | | | | |
| | AQ | 5,165,390 | 11/24/92 | FLEETWOOD | | | | |
| ✓ | AR | 5,755,677 | 5/26/98 | MASUDA ET AL. | | | | |
| FOREIGN PATENT DOCUMENTS | | | | | | | | |
| | | DOCKET NUMBER | DATE | COUNTRY | CLASS | SUBCLASS | TRANSLATION | |
| | | | | | | | YES | NO |
| | AS | NONE | | | | | | |
| | AT | | | | | | | |
| | AU | | | | | | | |
| OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.) | | | | | | | | |
| | AV | NONE | | | | | | |
| | AW | | | | | | | |
| | AX | | | | | | | |
| EXAMINER | | | | | DATE CONSIDERED 9/28/04 | | | |
| EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant. | | | | | | | | |



FORM PTO-1449

U.S. DEPARTMENT OF COMMERCE
PATENT AND TRADEMARK OFFICE

ATTORNEY DOCKET NO. 1683.018

SERIAL NO.10/623,955

LIST OF ART CITED BY APPLICANT
(Use several sheets if necessary)

APPLICANT: Mr. Hakjin Kim

FILING DATE: Herewith

GROUP

U.S. PATENT DOCUMENTS

| Examiner Initial | | DOCKET NUMBER | DATE | NAME | CLASS | SUBCLASS | FILING DATE IF APPROPRIATE |
|------------------|----|---------------|----------|---------------|-------|----------|----------------------------|
| OT | BA | 5,807,288 | 9/15/98 | WU | X | X | |
| | BB | 6,071,252 | 6/06/00 | MARCANTONI | | | |
| | BC | 6,190,338 | 2/20/01 | ARNDT | | | |
| | BD | 6,224,563 | 5/01/01 | NONOUE ET AL. | | | |
| | BE | 6,243,609 | 6/05/01 | LEE | | | |
| | BF | 6,409,689 | 6/25/02 | CHEN | | | |
| | BG | 6,454,732 | 9/24/02 | LEE | | | |
| | BH | 2002/0138023 | 9/26/02 | KUME ET AL. | | | |
| | BI | 2002/0193713 | 12/19/02 | LEE | | | |
| | BJ | 2003/0018284 | 1/23/03 | LIM | | | |
| | BK | 6,542,779 | 4/01/03 | LEE | | | |
| ✓ | BL | 6,555,798 | 4/29/03 | LEE | | | |
| | BM | | | | | | |
| | BN | | | | | | |
| | BO | | | | | | |
| | BP | | | | | | |
| | BQ | | | | | | |
| | BR | | | | | | |

FOREIGN PATENT DOCUMENTS

| | | DOCKET NUMBER | DATE | COUNTRY | CLASS | SUBCLASS | TRANSLATION | |
|--|----|---------------|------|---------|-------|----------|-------------|----|
| | | | | | | | YES | NO |
| | BS | NONE | | | | | | |
| | BT | | | | | | | |
| | BU | | | | | | | |

OTHER ART (Including Author, Title, Date, Pertinent Pages, etc.)

| | | |
|--|----|------|
| | BV | NONE |
| | BW | |
| | BX | |

EXAMINER

DATE CONSIDERED

9/28/04

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.